# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





# HMC460LC5

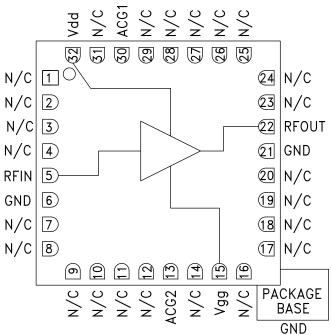
### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz

### Typical Applications

The HMC460LC5 is ideal for:

- Telecom Infrastructure
- Microwave Radio & VSAT
- Military & Space
- Test Instrumentation

### **Functional Diagram**



#### Features

Noise Figure: 2.5 dB @ 10 GHz Gain: 14 dB @ 10 GHz P1dB Output Power: +16.5 dBm @ 10 GHz Supply Voltage: +8V @ 75 mA 50 Ohm Matched Input/Output 32 Lead Ceramic 5 x 5 mm SMT Package: 25 mm<sup>2</sup>

### **General Description**

The HMC460LC5 is a GaAs MMIC pHEMT Low Noise Distributed Amplifier in a leadless 5 x 5 mm ceramic surface mount package which operates from DC to 20 GHz. The amplifier provides 14 dB of gain, 2.5 dB noise figure and +16.5 dBm of output power at 1 dB gain compression while requiring only 75 mA from a Vdd = 8V supply. Gain flatness is excellent from DC to 20 GHz making the HMC460LC5 ideal for EW, ECM, Radar and test equipment applications. The wideband amplifier I/Os are internally matched to 50 Ohms.

### Electrical Specifications, $T_{a} = +25 \text{ °C}$ , Vdd= 8V, Idd= 75 mA\*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	DC - 6.0		6.0 - 18.0		18.0 - 20.0			GHz		
Gain	11	14		11	14		10	13		dB
Gain Flatness		± 0.5			± 0.15			± 0.25		dB
Gain Variation Over Temperature		0.008			0.01			0.01		dB/ °C
Noise Figure		3.5	5.0		2.5	4.0		3.5	5	dB
Input Return Loss		17			18			12		dB
Output Return Loss		17			15			15		dB
Output Power for 1 dB Compression (P1dB)	14	17		13	16		12	15		dBm
Saturated Output Power (Psat)		18			18			17		dBm
Output Third Order Intercept (IP3)		29.5			29			28.5		dBm
Supply Current (Idd) (Vdd= 8V, Vgg= -0.9V Typ.)		75			75			75		mA

\*Adjust Vgg between -2 to 0V to achieve Idd= 75 mA typical.

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

# HMC460LC5\* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

### COMPARABLE PARTS

View a parametric search of comparable parts.

### EVALUATION KITS

• HMC460LC5 Evaluation Board

### DOCUMENTATION

#### **Application Notes**

- AN-1363: Meeting Biasing Requirements of Externally Biased RF/Microwave Amplifiers with Active Bias Controllers
- Broadband Biasing of Amplifiers General Application Note
- MMIC Amplifier Biasing Procedure Application Note
- Thermal Management for Surface Mount Components General Application Note

#### Data Sheet

HMC460LC5: GaAs pHEMT MMIC Low Noise Amplifier, DC
20 GHz Data Sheet

### TOOLS AND SIMULATIONS $\square$

HMC460LC5 S-Parameters

### REFERENCE MATERIALS

#### **Quality Documentation**

- Package/Assembly Qualification Test Report: LC5, LC5A (QTR: 2014-00384 REV: 01)
- Semiconductor Qualification Test Report: PHEMT-F (QTR: 2013-00269)

### DESIGN RESOURCES

- HMC460LC5 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

### DISCUSSIONS

View all HMC460LC5 EngineerZone Discussions.

### SAMPLE AND BUY

Visit the product page to see pricing options.

### TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK

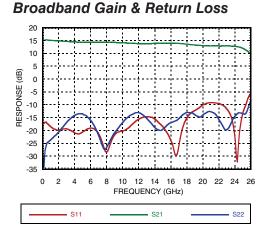
Submit feedback for this data sheet.

This page is dynamically generated by Analog Devices, Inc., and inserted into this data sheet. A dynamic change to the content on this page will not trigger a change to either the revision number or the content of the product data sheet. This dynamic page may be frequently modified.

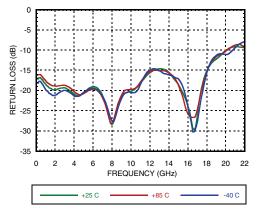


v05.0217

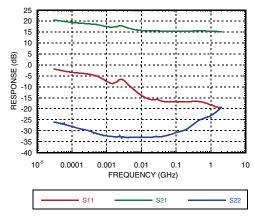
### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz



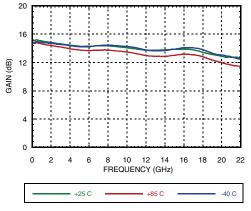
Input Return Loss vs. Temperature



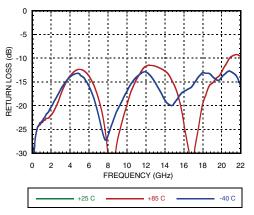
Low Frequency Gain & Return Loss



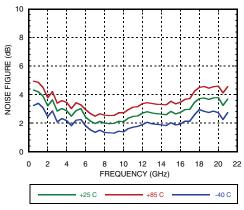




Output Return Loss vs. Temperature



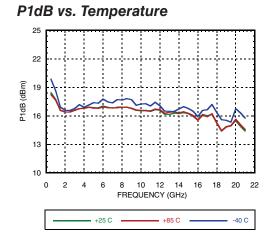




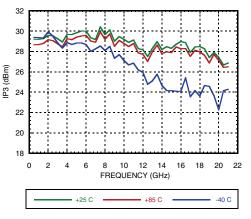


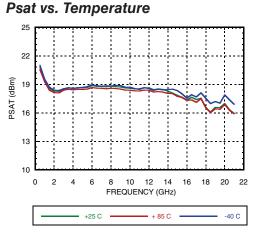
v05.0217

### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz

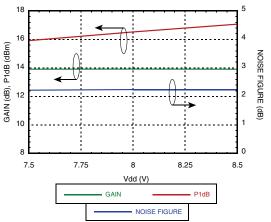


**Output IP3 vs. Temperature** 

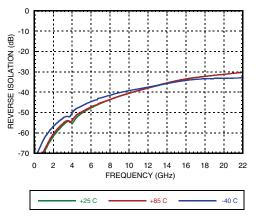




Gain, Power & Noise Figure vs. Supply Voltage @ 10 GHz, Fixed Vgg



### **Reverse Isolation vs. Temperature**





# HMC460LC5

### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz

### Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+9 Vdc	
Gate Bias Voltage (Vgg)	-2 to 0 Vdc	
Gate Bias Voltage (Igg)	2.5 mA	
RF Input Power (RFIN)(Vdd = +8 Vdc)	+18 dBm	
Channel Temperature	175 °C	
Continuous Pdiss (T = 85 °C) (derate 23 mW/°C above 85 °C)	2 W	
Thermal Resistance (channel to package bottom)	44.4 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-55 to +85 °C	
ESD Sensitivity (HBM)	Class 1A	

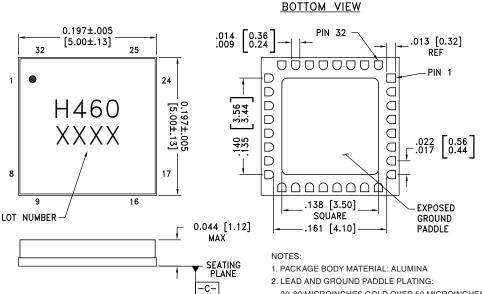
### Typical Supply Current vs. Vdd

Vdd (V)	ldd (mA)
+7.5	74
+8.0	75
+8.5	76



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

### **Outline Drawing**



30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.

3. DIMENSIONS ARE IN INCHES [MILLIMETERS].

4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.

5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-

6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

### **Package Information**

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[2]</sup>	
HMC460LC5	Alumina, White	Gold over Nickel	MSL3 <sup>[1]</sup>	H460 XXXX	

[1] Max peak reflow temperature of 260  $^\circ\text{C}$ 

[2] 4-Digit lot number XXXX



### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz

HMC460LC5

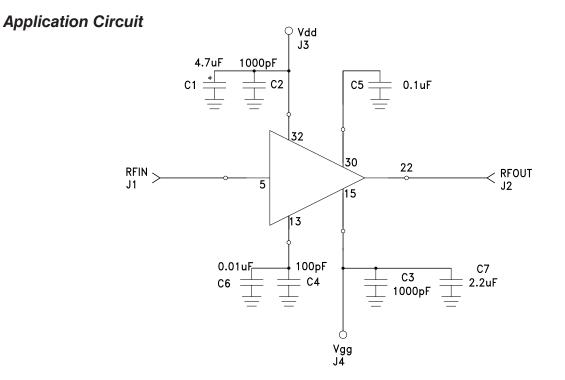
### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic	
1 - 4, 7 - 12, 14, 16 - 20, 23 - 29, 31	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.		
5	RFIN	This pin is DC coupled and matched to 50 Ohms.	RFIN ACG2	
6, 21	GND	Package bottom must be connected to RF/DC ground.		
13	ACG2	Low frequency termination. Attach bypass capacitor per application circuit herein.	RFIN ACG2	
15	Vgg	Gate control for amplifier. Please follow"MMIC Amplifier Biasing Procedure" application note	VggÖ	
22	RFOUT	This pin is DC coupled and matched to 50 Ohms.	O RFOUT	
30	ACG1	Low frequency termination. Attach bypass capacitor per application circuit herein.	ACG1 RFOUT	
32	Vdd	Power supply voltage for the amplifier. External bypass capacitors are required	OVdd ↓↓ ↓ ↓	



v05.0217

### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz

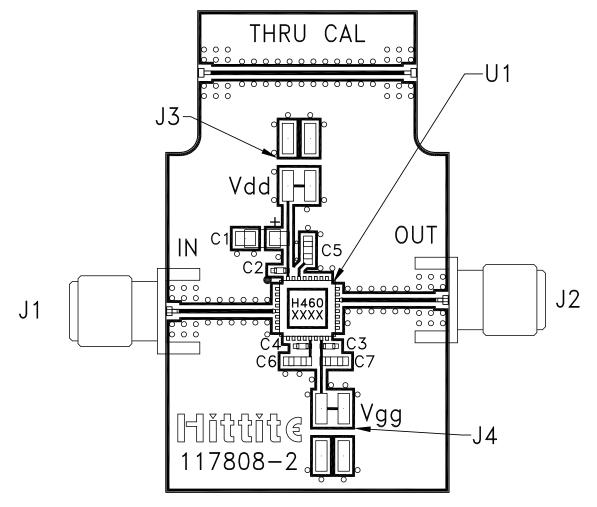




v05.0217

### GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz

### **Evaluation PCB**



### List of Materials for Evaluation PCB 117810 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 - J4	2 mm Molex Header
C4	100 pF Capacitor, 0402 Pkg.
C2, C3	1000 pF Capacitor, 0402 Pkg.
C1	4.7 µF Capacitor, Tantalum
C5	0.1 uF Capacitor, 0603 Pkg.
C6	0.01 uF Capacitor, 0603 Pkg.
C7	2.2 uF Capacitor, 0603 Pkg.
U1	HMC460LC5
PCB [2]	117808 Evaluation PCB

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Analog Devices, upon request.



## HMC460LC5

GaAs pHEMT MMIC LOW NOISE AMPLIFIER, DC - 20 GHz